

TN9928JNPA

Dual N-Channel Enhancement Mode Power MOSFET

Product Summary

- V_{DS}= 20V,I_D= 10.5A
- $R_{DS(on)}$ < 18m Ω @ V_{GS} = 4.5V
- $R_{DS(on)} < 25m\Omega @V_{GS} = 2.5V$

Features

- Advanced Trench Technology
- RoHS and Reach Compliant
- Halogen and Antimony Free
- Moisture Sensitivity Level 3

Application

- Power Switching Application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

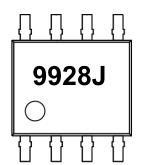
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SOP-8

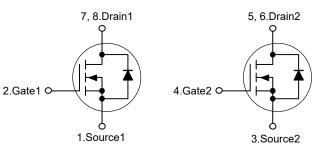
(Top View)

Pin	Description	Pin	Description
1	Source1	4	Gate2
2	Gate1	5,6	Drain2
3	Source2	7,8	Drain1

Marking Code



Schematic Diagram



N-Channel

N-Channel

Absolute Maximum Ratings

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	20	V
Gate-Source Voltage	V _{GS}	±12	V
Drain Current-Continuous	I _D	10.0	Α
Drain Current-Pulsed Note1	I _{DM}	40	Α
Maximum Power Dissipation	P _D	2.0	W
Junction Temperature	TJ	150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Thermal Characteristics

Thermal Resistance,Junction-to-Ambient Note2	R _{θJA}	62.5	°C/W
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Electrical Characteristics

(T_J=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Off Characteristics	•				•	
Drain-Source Breakdown Voltage	BV _{DSS}	$V_{GS} = 0V, I_{D} = 250 \mu A$	20			V
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30V, V_{GS} = 0V$			1	μΑ
Gate Body Leakage Current, Forward	I _{GSSF}	$V_{GS} = 8V, V_{DS} = 0V$			100	nA
Gate Body Leakage Current, Reverse	Igssr	V_{GS} = -8V, V_{DS} = 0V			-100	nA
On Characteristics						
Gate Threshold Voltage	V _{GS(th)}	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	0.4		1	V
Static Drain-Source		$V_{GS} = 4.5V, I_{D} = 4A$			18	mΩ
On-Resistance	R _{DS(on)}	V _{GS} = 2.5V, I _D = 2A			25	mΩ
Dynamic Characteristics d						
Input Capacitance	C _{iss}	\/ 40\/\\ 0\/		1400		pF
Output Capacitance	C _{oss}	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1 0 MHz		205		pF
Reverse Transfer Capacitance	C _{rss}	1		165		pF
Switching Characteristics d						
Turn-On Delay Time	t _{d(on)}			18		ns
Turn-On Rise Time	t _r	$V_{DD} = 15V, I_{D} = 5A,$		11		ns
Turn-Off Delay Time	t _{d(off)}	$t_{d(off)}$ $V_{GS} = 5V, R_{GEN} = 3\Omega$		48		ns
Turn-Off Fall Time	t _f			10		ns
Total Gate Charge	Qg	\/ - 45\/ -50		18		nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 15V, I_{D} = 5A,$ $V_{GS} = 4.5V$		3.5		nC
Gate-Drain Charge	Q _{gd}	1 65		4		nC
Drain-Source Diode Characteristics and Maximun Ratings						
Drain-Source Diode Forward Current ^b	I _S				1.7	Α
Drain-Source Diode Forward Voltage °	V _{SD}	V _{GS} = 0V, I _S = 1.7A			1.2	V

Notes : □
a Repetitive Rating : Pulse width limited by maximum junction temperature. □
b Surface Mounted on FR4 Board, t ≤ 10 sec. □
c.Pulse Test : Pulse Width ≤ 300µs, Duty Cycle ≤ 2%. □
d.Guaranteed by design, not subject to production testing. □

Typical Characteristic Curves

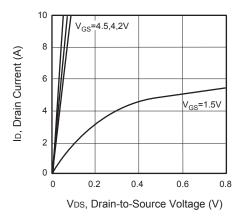


Figure 1. Output Characteristics

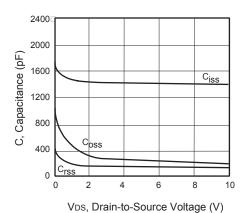


Figure 3. Capacitance

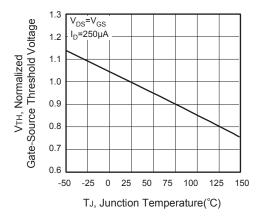


Figure 5. Gate Threshold Variation with Temperature

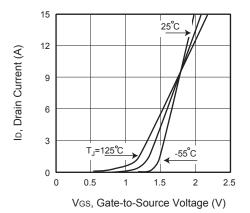


Figure 2. Transfer Characteristics

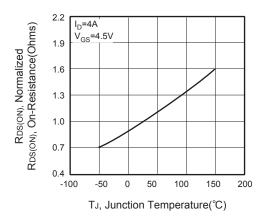


Figure 4. On-Resistance Variation with Temperature

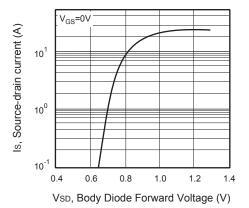


Figure 6. Body Diode Forward Voltage Variation with Source Current

Typical Characteristic Curves

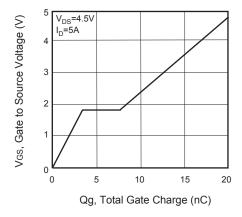


Figure 7. Gate Charge

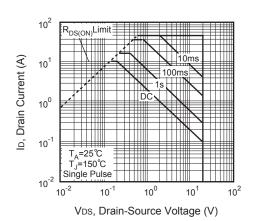


Figure 8. Maximum Safe Operating Area

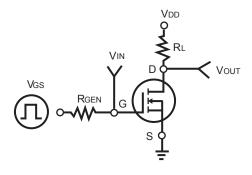


Figure 9. Switching Test Circuit

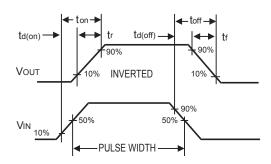


Figure 10. Switching Waveforms

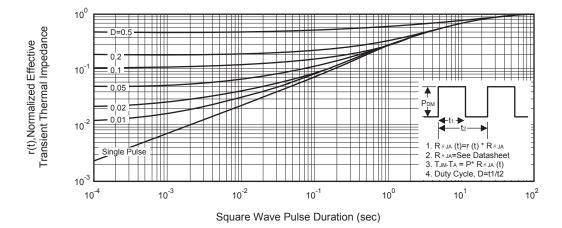
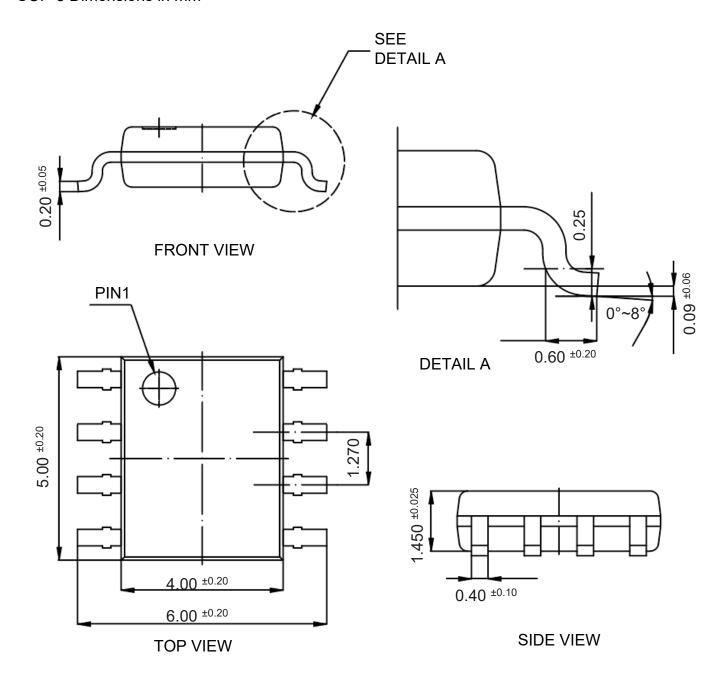


Figure 11. Normalized Thermal Transient Impedance Curve

Package Outline

SOP-8 Dimensions in mm



Ordering Information

Device	Package	Shipping
TN9928JNPA	SOP-8	4,000PCS/Reel&13inches

Contact Information

For additional information, please contact your local Sales Representative.



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